# **Tyrone Camarero Specifications**



## Camarero-SDI100C3S-212H

### **Key Feature**

Enterprise Server, iSCSI SAN, HPC, Data Center, Database Processing & Storage, Corporate Database

- Dual Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable Processors
- 16 ECC DDR4-3200: LRDIMM/RDIMM + 2 Intel® Optane™ Persistent Memory Dedicated Slots
- 2x 10Gbe
- 12x 3.5" hot-swap hybrid SATA/SAS drive bays (4 NVMe Hyprid Ports); 2 rear SATA 2.5" slots; onboard 1 M.2 NVMe
- 3 heavy duty fans with optimal fan speed control; 1 Air Shroud
- 1200W Redundant Titanium Level power supplies
- Broadcom® 3916 controller





#### Processor/Cache

Processor Dual Socket P+ (LGA-4189), 3rd Gen Intel®

Xeon® Scalable processors, Support CPU

TDP 120-270W

#### System Memory

Memory Capacity

Memory Capacity: 16 DIMM slots, Up to 4TB: 16x 256 GB DRAM, Memory Type:

3200MHz ECC DDR4 RDIMM;LRDIMM;DCPMM

#### Chipset

Chipset Intel® C621A

#### **Expansion Slot**

PCI-Express "4 PC

"4 PCle 4.0 x16 LP slot(s), 1 PCle 4.0 x8 LP

slot(s)

Note

PCIe slot 1 is occupied by the Storage

Controller"

#### Integrated Onboard:

IPMI

Support for Intelligent Platform Management Interface v.2.0, IPMI 2.0 with virtual media over

LAN and KVM-over-LAN support

Network

2x 10GbE BaseT with Intel® X550

Connectivity

#### Add-on Options

**Raid Card** 

Optional

Optical Drive None

Front Panel

HDD activity, Network activity, Power

status, System information

(overheat/UID)

**Buttons** Power On/Off button

Drive bays

**HDD Bays** "12x 3.5"" hot-swap SATA3/SAS3 drive

bays (4x 2.5"" NVMe hybrid; 4x 3.5"" NVMe hybrid) M.2: 1 M.2 NVMe"

**Power Supply** 

Power Supply 1200W Redundant Titanium Level

power supplies

**Cooling System** 

Fans 3 Heavy Duty 8cm Fan(s)

Form Factor

Form Factor 2U Rackmount

Dimensions

**Dimensions** "Dimension : Height : 3.5", Width

17.3", Dept: 25.5"

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